Product data sheet

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1. General description

The ESDHDxxBB series are designed to protect voltage sensitive components which are connected to data and transmission lines from overvoltage caused by ESD (electrostatic discharge), CDE (Cable Discharge Events), and EFT (electrical fast transients). Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium.



2. Features and benefits

- · Transient protection for high-speed data lines
- Peak pulse power 90W @ 8/20µs waveform
- IEC 61000-4-2 (ESD) ±30kV(air), ±30kV(contact)
- Protects Bi-directional I/O line
- · Low clamping voltage
- Low leakage current
- Meet MSL level1
- Halogen free and RoHS compliant



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3. Applications

- Computer Interfaces Protection
- Microprocessors Protection
- Serial and Parallel Ports Protection
- Control Signal Lines Protection
- Power lines on PCB Protection
- Portable instrumentation
- Peripherals

4. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
ESDHDxxBB	SOD523	ESDHDxxBBX	Tape and reel	3000	SOD523X	12-Nov-2021
ESDHD03BB	SOD523	ESDHD03BBX	Tape and reel	3000	SOD523X	12-Nov-2021

5. Absolute maximum ratings

In accordance with the Absolute Maximum Rating System (IEC 60134). $T_{c} = 25 \, ^{\circ}\text{C}$ unless otherwise specified

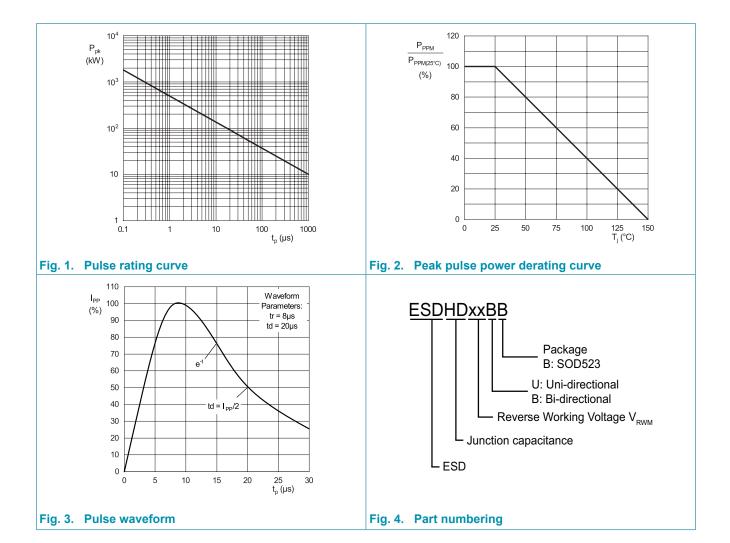
Symbol	Parameter	Conditions	Values	Unit		
Absolute maximum rating						
P _{PPM}	peak pulse power	t _p = 8/20 μs	90	W		
V _{ESD}	ESD per IEC 61000-4-2 (air) ESD per IEC 61000-4-2 (contact)		±30 ±30	kV kV		
T _{stg}	storage temperature range		-55 to 150	°C		
Tj	operating temperature range		-55 to 150	°C		

ESD Protection Diodes

6. Characteristics

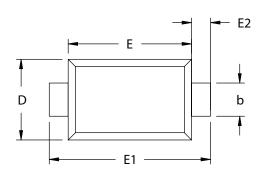
T_i = 25 °C unless otherwise specified.

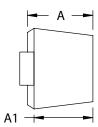
Product type	Reverse Stand off Voltage V _R (V)	Min. Breakdown Voltage V _{BR} @ I _T = 1 mA (V)	Max. Clamping Voltage V _c @ I _{pp} = 1 A (V)	Max. Clamping Voltage V _c @ Max I _{pp} (V)	Max. Peak Pulse current I _{pp} @ 8/20 μs (A)	Maximum Reverse Leakage I _R @ V _R (μA)	Typ. C _j (pF) @ 0 V, 1 MHz
ESDHD03BB	3.3	3.7	7	9	10	1	15
ESDHD05BB	5.0	5.6	8.5	10	9	1	15

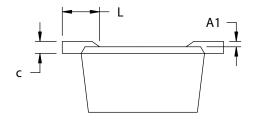


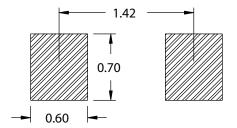
7. Package outline

SOD523









Recommended Footprint

Note:

1. All dimensions do not include mold flash and gate remain.

Unit		Α	A1	A2	b	С	D	E	E1	E2	L
MM	MIN	0.51	0.50	0.01	0.25	0.08	0.75	1.10	1.50	(0.20)	0.30
IVIIV	MAX	0.77	0.70	0.07	0.35	0.15	0.85	1.30	1.70	(0.20)	0.50

ESD Protection Diodes

8. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- The term 'short data sheet' is explained in section "Definitions".
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